

FrelTec GmbH

Mathildenstr. 10A
82319 Starnberg
Germany

SMD Inductors Beads for Power Lines

SPECIFICATION

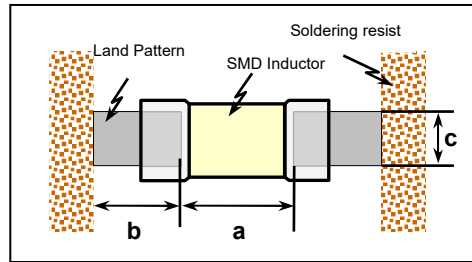
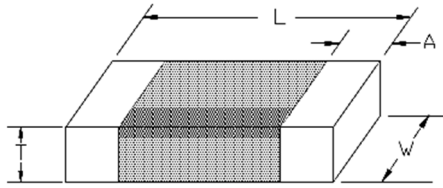
Part Number

15P	02*	151*	S	M	T10*	5
Type	Size	Impedance	Specificat- ion	Tolerance	Packing	Thick-ness
15P : SMD Inductor Bead for Power Lines	02 : 0402 1,0x0,5mm	The value is given in Ohm. First two digits are significant The last digit is the multiplier which denotes the number of zero following	S: Standard Type	Q: ±25%	E03: Embossed plastic type and reel. For 3k pc available for 1206 (7"reel)	5: 0,5 mm
	03 : 0603 1,6x0,8mm		R: Low DRC		T04: Tape paper and reel. For 4k pc available for 0603, 0805 (7"reel)	8: 0,8 mm
	05 : 0805 2,0x1,2mm	Example: 670 : 670Ohm 371 : 370Ohm 222 : 2200 Ohm	G: for GHz Band	T10: Tape paper and reel. For 10k pc available for 0402 (7"reel)		9: 0,9 mm
	06 : 1206 3,2x1,6mm				B: 1,1 mm	

All products according to RoHS (2015/863/EU)

SMD

Dimensions and land pattern:



Series	L	W	A (Min/Max)	Recommended Pad Dimensions			
				L x W	a	b	c
0402	1,00 ± 0,10	0,50 ± 0,10	0,25 ± 0,15	1,0 x 0,5	0,3 to 0,5	0,35 to 0,45	0,4 to 0,5
0603	1,60 ± 0,20	0,80 ± 0,20	0,30 ± 0,20	1,6 x 0,8	0,7 to 1,0	0,6 to 0,8	0,7 to 0,8
0805	2,00 ± 0,20	1,20 ± 0,20	0,50 ± 0,30	2,0 x 1,2	1,0 to 1,3	0,7 to 0,9	1,0 to 1,2
1206	3,20 ± 0,20	1,60 ± 0,20	0,50 ± 0,30	3,2 x 1,6	2,1 to 2,5	1,0 to 1,2	1,3 to 1,6

in mm

FrelTec

SMD Characteristic

Size	Thickness(mm)		Impedance(Ω)		Impedance Tolerance %	DC Resistance m Ω (Max)	Rated Current mA(Max)	Measuring
	Max.	Tol.	Value	3-Digital				
0402	0,50	$\pm 0,03$	10	100		30,0	2,000	100MHz/0.5V
			30	300		35,0	2,200	
			60	600		60,0	1,700	
			70	700		90,0	1,200	
			80	800		70,0	1,500	
			100	101		90,0	1,200	
			180	181		90,0	1,200	
0402	0,50	$\pm 0,03$	120	121		55,0	2,000	
0603	0,80	$\pm 0,20$	19	190	$\pm 25\%$	40,0	3,000	
			22	220		40,0	3,000	
			30	300		30,0	3,000	
			31	310		40,0	3,000	
			33	330		25,0	3,000	
			50	500		40,0	3,000	
			60	600		40,0	3,000	
			70	700		40,0	3,000	
			80	800		40,0	3,000	
			100	101		40,0	3,000	
			120	121		40,0	3,000	
			150	151		40,0	3,000	
			180	181		90,0	1,500	
			220	221		50,0	3,000	
0603	0,08	$\pm 0,15$	300	301		90,0	2,000	
			330	331		80	1,700	
			600	601		200,0	1,000	
			1000	102		200,0	1,000	
			7	070		25,0	4,000	
			22	220		8,0	6,000	
			26	260		7,0	6,000	
0805	0,90	$\pm 0,20$	30	300		10,0	5,000	
			33	330		8,0	6,000	
			60	600		20,0	3,500	
			100	101		10,0	6,000	
			7	070		8,0	6,000	
			11	110		8,0	6,000	
			22	220		8,0	6,000	
			30	300		8,0	6,000	
			50	500		20,0	4,000	
			60	600		15,0	5,000	
			80	800		10,0	5,000	
100	800		40,0	3,000				
120	121		20,0	4,000				
180	181		50,0	3,000				
220	221		50,0	3,000				
300	301		40,0	3,000				
330	331		50,0	3,000				
470	471		100,0	2,000				
600	601		100,0	2,000				

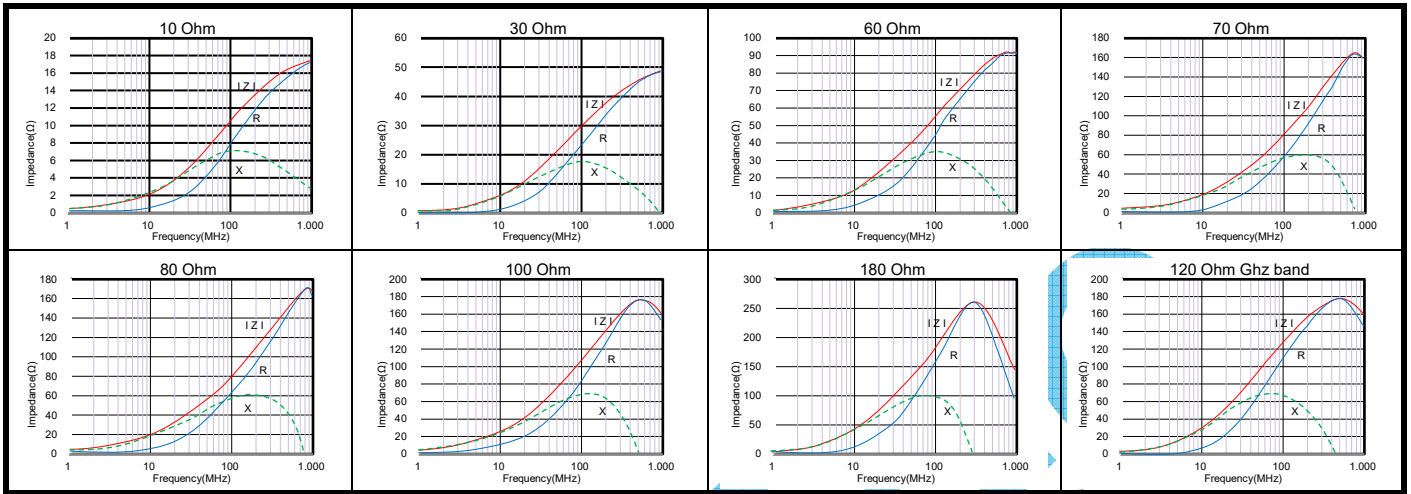
SMD

Beads for Power Lines

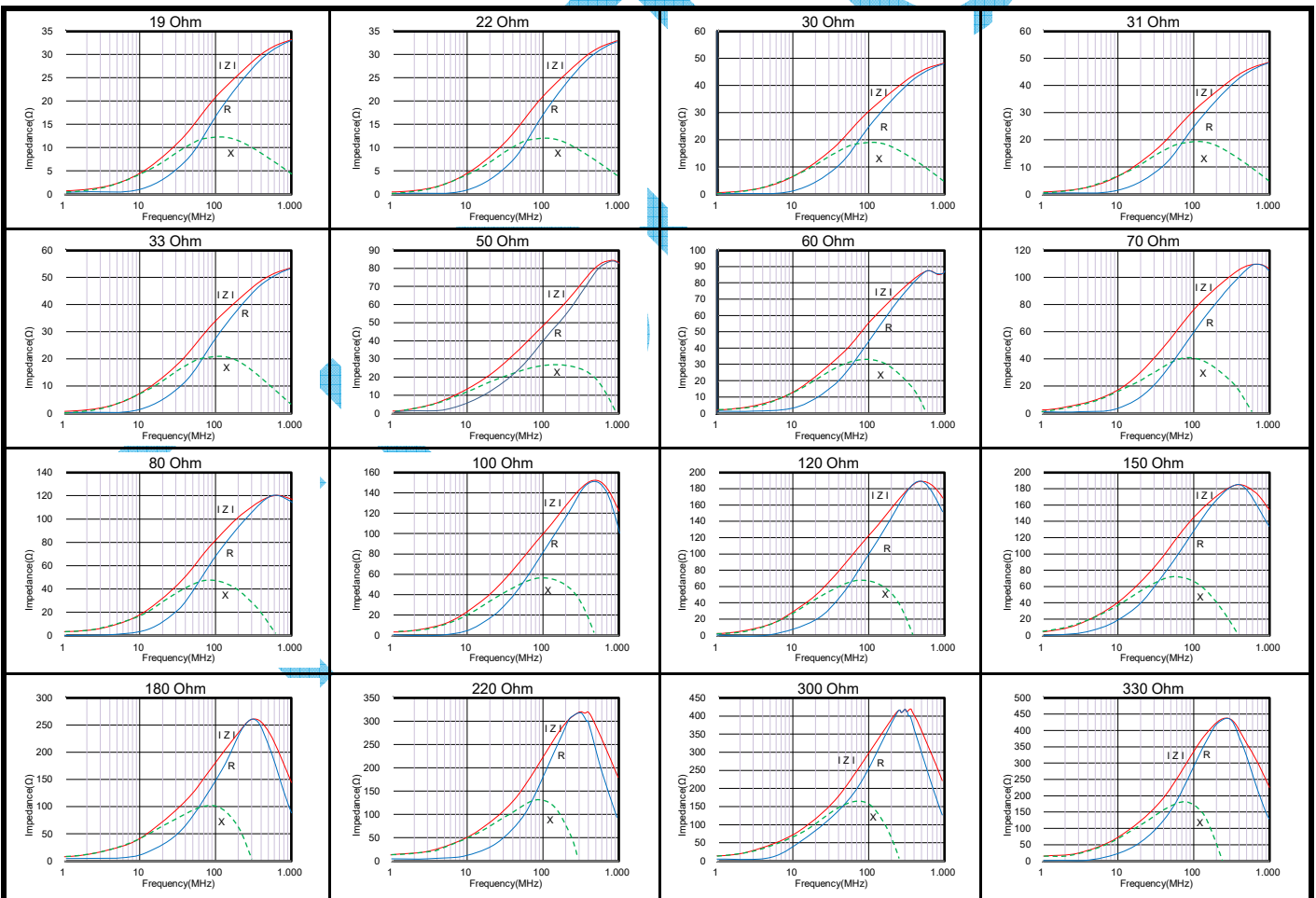
Size	Thickness(mm)		Impedance(Ω)		Impedance Tolerance %	DC Resistance m Ω (Max)	Rated Current mA(Max)	Measuring
	Max.	Tol.	Value	3-Digital				
			750	751		300,0	1,000	
			1000	102		300,0	1,000	
			1200	122		300,0	1,000	
			1500	152		300,0	1,000	
			19	190		6,0	6,000	
1206	1,10	$\pm 0,20$	26	260	6,0	6,000		
			30	300	6,0	6,000		
			31	310	6,0	6,000		
			33	330	6,0	6,000		
			52	520	8,0	6,000		
			60	600	10,0	6,000		
			80	800	20,0	4,000		
			120	121	25,0	6,000		
			150	151	120,0	3,000		
			180	181	50,0	3,000		
			200	201	50,0	3,000		
			220	221	50,0	3,000		
			300	301	60,0	3,000		
			500	501	60,0	3,000		
			600	601	60,0	3,000		
			1000	102	30,0	1,000		

OPERATING TEMPERATURE RANGE: -55°C TO +125°C

0402

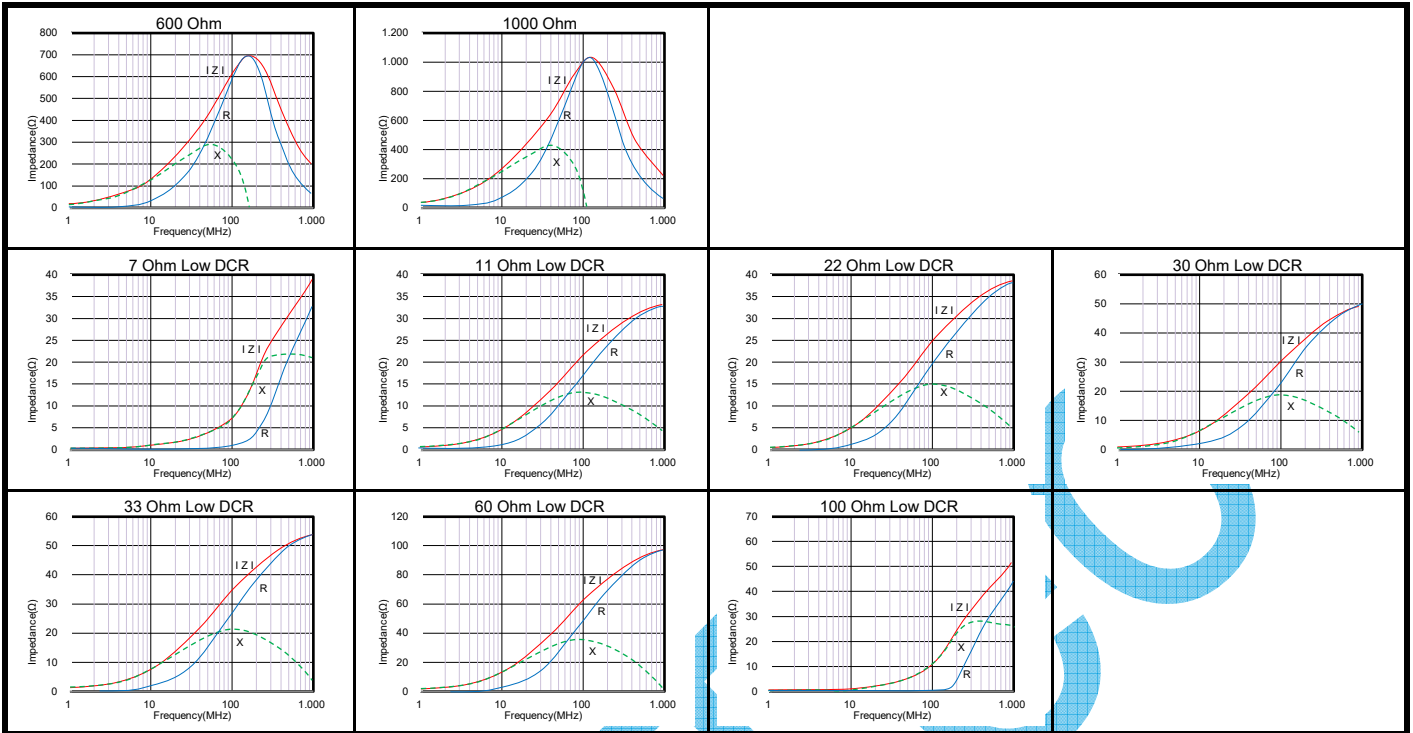


0603

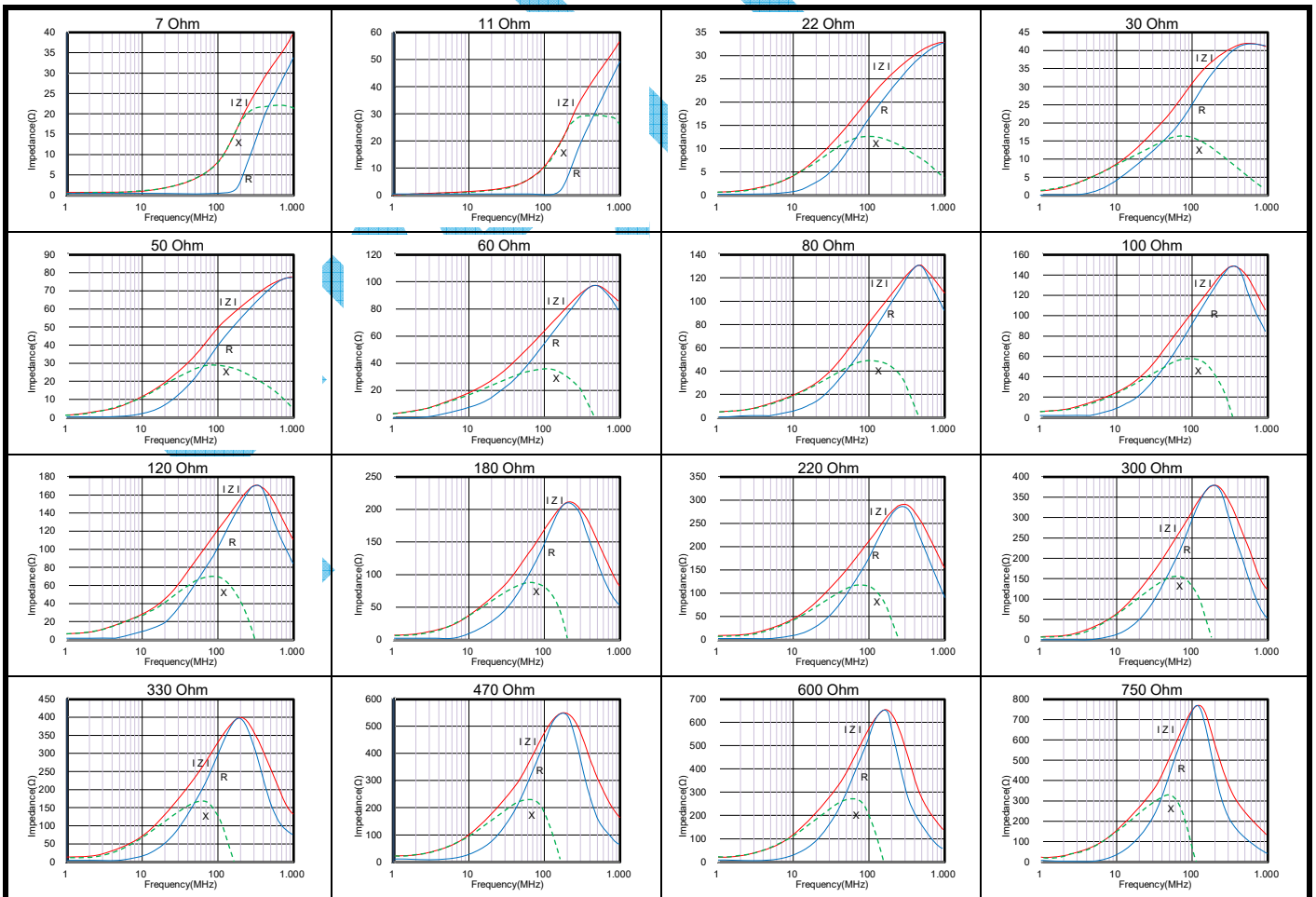


SMD

Beads for Power Lines

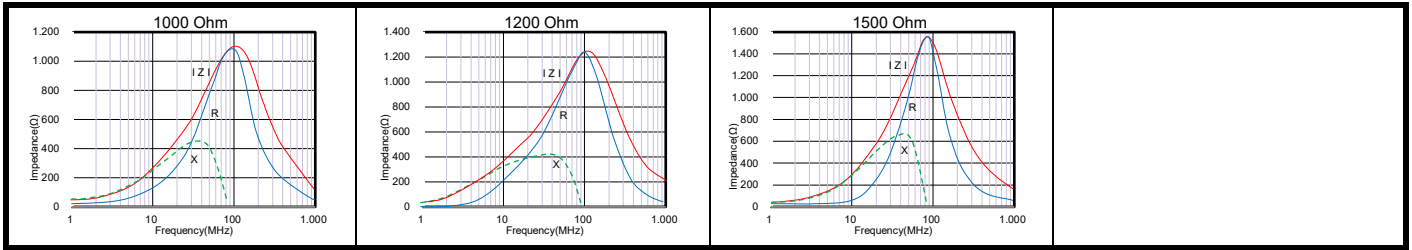


0805

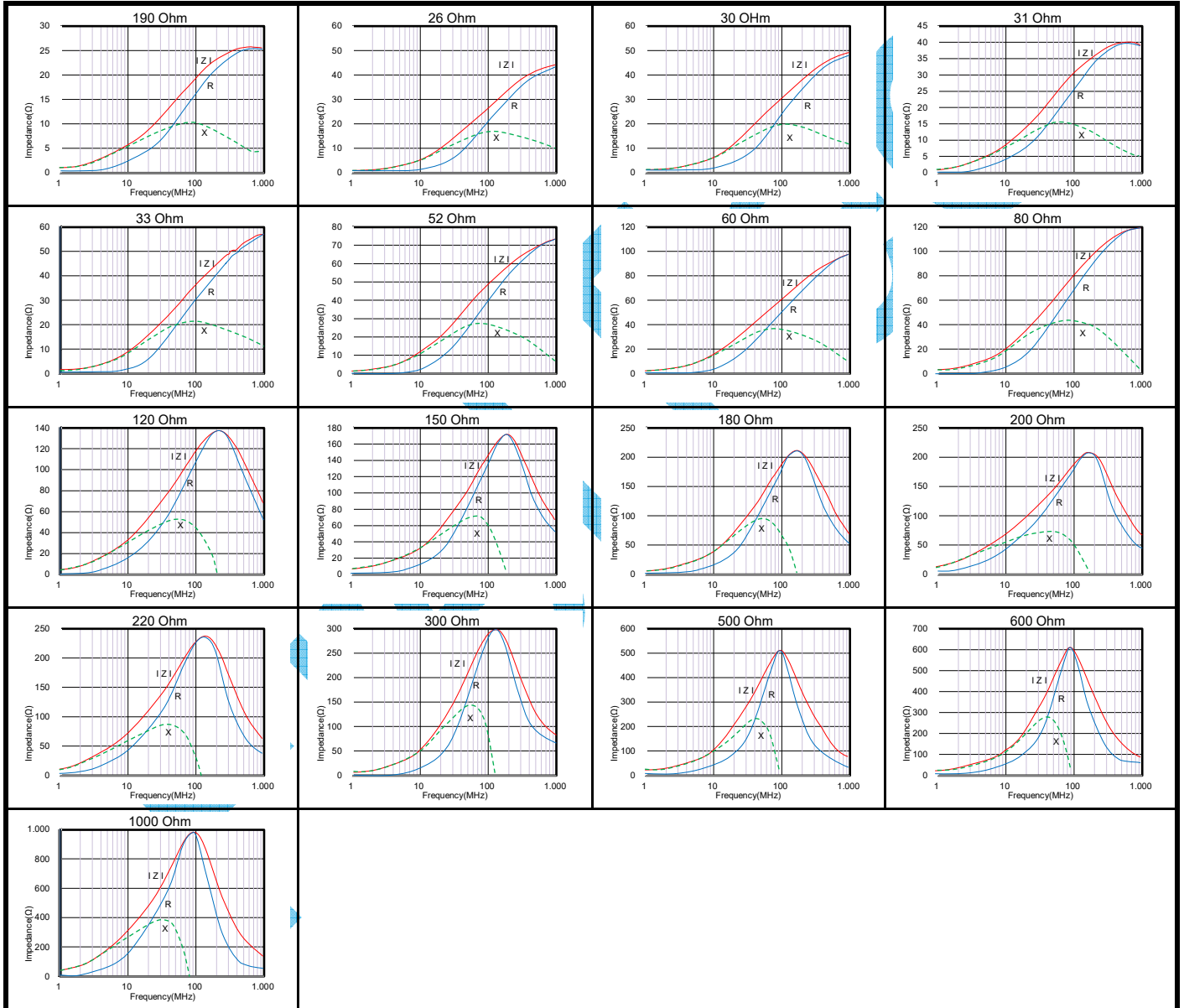


SMD

Beads for Power Lines



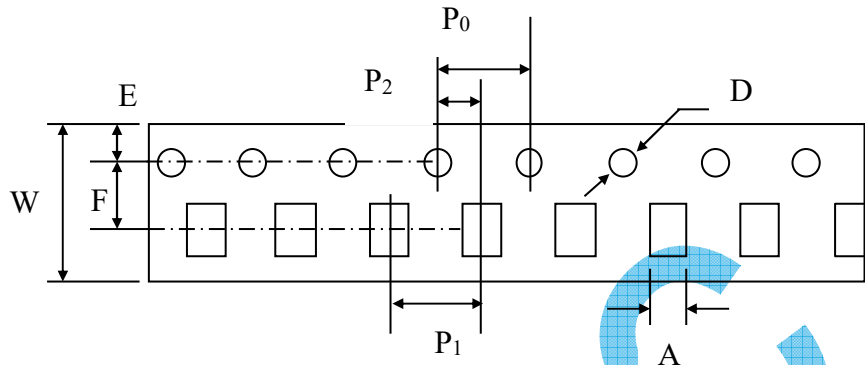
1206



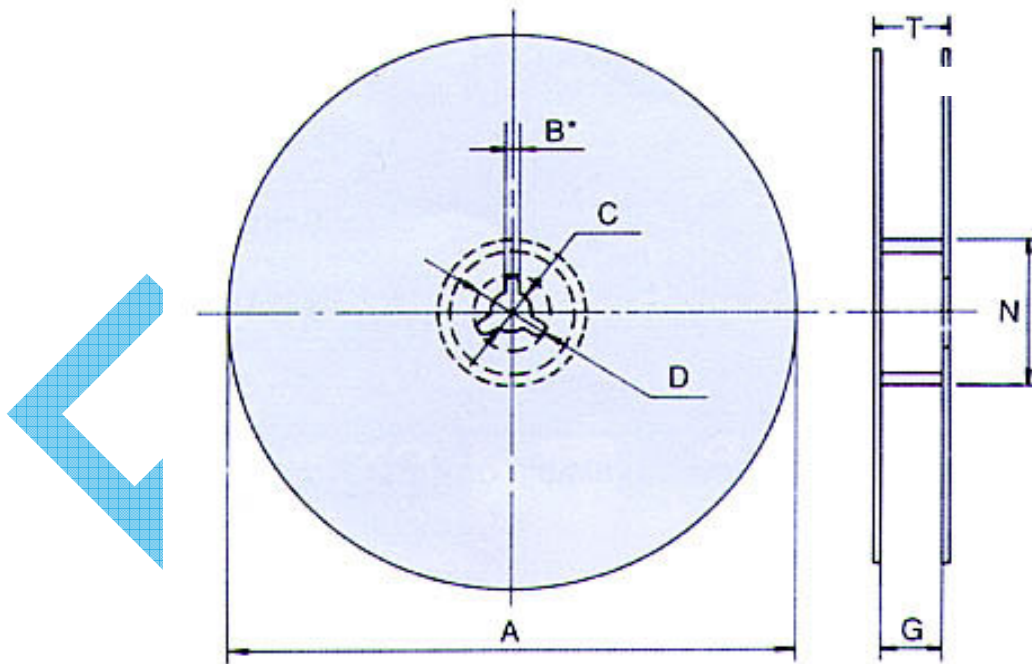
SMD

SPECIFICATION

Tape And Reel Package



Size	W	P ₁	F	A	E	P ₂	P ₀	D
0402	8,00 ± 0,10	4,00 ± 0,10	3,50 ± 0,05	0,62 ± 0,03	1,12 ± 0,03	2,00 ± 0,05	2,00 ± 0,05	1,55 ± 0,05
0603	8,00 ± 0,10	4,00 ± 0,10	3,50 ± 0,10	1,05 ± 0,05	1,85 ± 0,05	2,00 ± 0,10	4,00 ± 0,10	1,56 ± 0,10
0805	8,00 ± 0,10	4,00 ± 0,10	3,50 ± 0,10	1,50 ± 0,05	2,30 ± 0,05	2,00 ± 0,10	4,00 ± 0,10	1,56 ± 0,10
1206	7,90-8,30	4,00 ± 0,10	3,50 ± 0,10	1,85 ± 0,10	3,43 ± 0,10	2,00 ± 0,05	4,00 ± 0,10	1,55 ± 0,05



Symbol		A	N	C	D	G	T
Dimension	Paper Tape	178±2	75	13,0±0,8	21,0±0,8	5,0	8
	Embossed Tape					10,0	12,5

in mm

SMD

Stock period

The performance of these products, including the solderability, is guaranteed for 12 months after production date code, provided that they remain packed as they were when delivered and stored at a temperature of 5°C to 35°C and a relative humidity less than 45 to 70%RH

Handling:

Keep the products away from all magnets and magnetic objects.

Be careful not to subject the products to excessive mechanical shocks.

Please avoid applying impact to the products after mounted on pc board.

Avoid ultrasonic cleaning

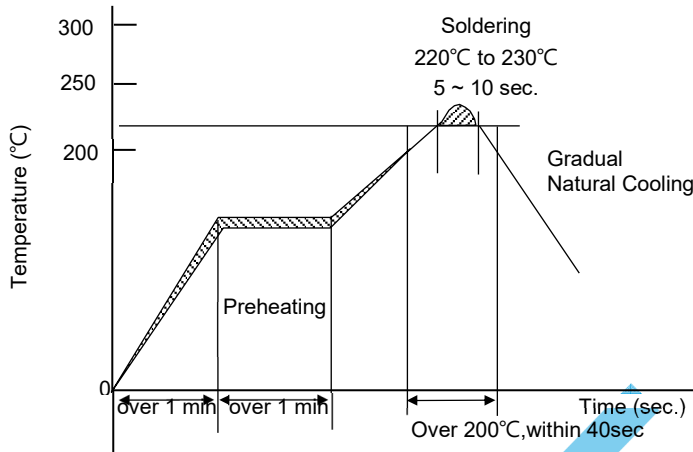
The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to dust or harmful gas (hydrogen chloride, sulfurous acid gas or hydrogen sulfide).

Packaging material may be deformed if packages are stored where they are exposed to heat or direct sun—light.

FrelTec

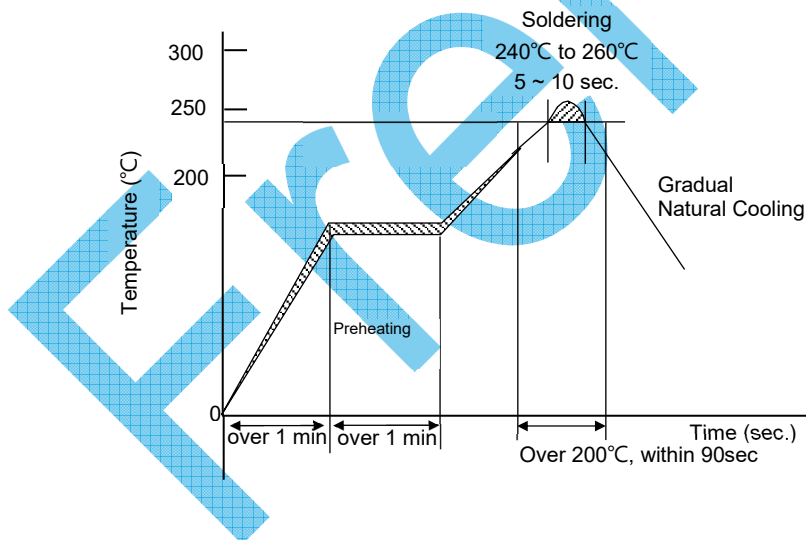
Soldering profile for SMT process with SNPB solder paste

The rate of preheat should not exceed 4°C/sec and a target of 2°C/sec is preferred. Ceramic chip components should be preheated to within 100 to 130°C of the soldering.



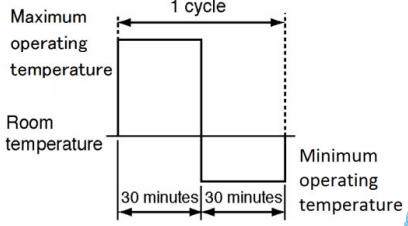
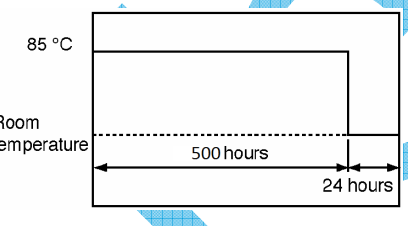
Soldering profile for SMT process with lead free solder paste.

The rate of preheat should not exceed 4°C/sec and a target of 2°C/sec is preferred. Ceramic chip components should be preheated to within 100 to 130°C of the soldering.



Test Conditions and Requirements

Item	Test Condition		Requirements
Appearance	Ferrite Beads shall be visually inspected for visible evidence of defect.		In accordance with specification.
Impedance	Measuring frequency : $100 \pm 1\text{MHz}$ Applied Voltage : 500 mV Measuring equipment and fixture : 1005 : HP4291B + 16193A 1608 : HP4291B + 16192A 2012 : HP4291A + 16092A 3216 : HP4291A + 16092A		Within specified tolerance.
DC Resistance	a. Temperature: $25 \pm 3^\circ\text{C}$ b. Relative Humidity: 45~75%RH c. Measuring equipment: HP 4338		In accordance with electrical specification.
Dimension	Dimension shall be measured with caliper or micrometer		In accordance with dimension specification.
Solder-ability	Preheat: 150°C , 60 seconds Solder temperature: $245 \pm 5^\circ\text{C}$ Flux: Rosin Dip time: 4 ± 1 seconds		More than 75% of the terminal electrode part shall be covered with new solder.
Bending Strength	Solder the chip to test jig then apply a force in the direction shown in below. The soldering shall be done with the reflow method and shall be conducted with care so that the soldering is uniform and free of defects such as heat shock. 		No mechanical damage shall be observed.
Resistance to Soldering Heat	Preheat: 150°C , 60 seconds Solder temperature: $270 \pm 5^\circ\text{C}$ Flux: Rosin Dip time: 10 ± 1 seconds		The chip shall not be cracks. More than 75% of terminal electrode shall be covered with solder.
High Humidity Load Life Test	Humidity: 90 to 95% RH. Temperature: $40 \pm 2^\circ\text{C}$ Testing time: 500 ± 12 hours		No visible damage. Impedance: Within $\pm 30\%$ of the initial value.

Item	Test Condition		Requirements
	Recovery: 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. Measurement: After placing for 24 ± 2 hours min.		
Thermal Shock	Temperature: Maximum and Minimum , kept stabilized for 30±3 minutes each Cycle: 5 cycles	 <p>The diagram shows a square wave cycle. The top horizontal segment is labeled 'Maximum operating temperature' and the bottom horizontal segment is labeled 'Minimum operating temperature'. The vertical segments represent transitions. A bracket above the cycle is labeled '1 cycle'. Below the cycle, two horizontal arrows indicate '30 minutes' for each of the high and low temperature stabilization periods.</p>	No visible damage Impedance: Within ± 30% of the initial value.
High Temperature Load	Temperature: 85±3°C 0603 125±3°C Testing time: 500±12 hours	 <p>The diagram shows a rectangular test profile. The top horizontal segment is labeled '85 °C' and the bottom horizontal segment is labeled 'Room temperature'. A bracket below the 85 °C segment is labeled '500 hours'. A bracket below the room temperature segment is labeled '24 hours'.</p>	No visible damage. Impedance: Within ± 30% of the initial value.
	Recovery: 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. Measurement : After placing for 24 ± 2 hours min.		

Published by FrelTec® GmbH
Mathildenstr. 10A; 82319 Starnberg; Germany
© 2023 FrelTec® GmbH. All Rights Reserved.

The following applies to all products named in this publication:

1. The information describes the type of component and shall not be considered as assured characteristics.
2. Terms of delivery and rights to change design reserved.
3. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. Nevertheless, we explicitly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, FrelTec® is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a FrelTec® product with the properties described in the product specification is suitable for use in a particular customer application.
4. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
5. The warnings, cautions and product-specific notes must be observed.
6. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as "hazardous"). Useful information on this will be found in our Material Data Sheets. Should you have any more detailed questions, please contact our sales offices.
7. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true for the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.
8. Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General conditions for the supply of products and services of the electrical and electronics industry" published by the German Electrical and Electronics Industry Association (ZVEI), available at www.freltec.com.
9. As far as patents or other rights of third parties are concerned, liability is only assumed for components per se, not for applications, processes and circuits implemented within components or assemblies.
10. The trade name FrelTec® is a trademark registered or pending in Europe and in other countries.